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HEET

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101045731

To the Honorable Commissioner of Patents

hed original documents or copy attached

1. Name of conveying party(ies):

Ming-Kwei Lee
Wen-Han Hung

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: **Winbond Electronics Corp.**

Internal Address:

Street Address: **No. 4 Creation Road III, Science-Based
Industrial Park**

City: **Hsinchu** Country: **Taiwan, R.O.C.**

Additional name(s) and address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: **May 4, 1999**

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: **May 4, 1999**

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Evan R. Witt, MADSON & METCALF**

Internal Address:

Street Address: **15 West South Temple, Suite 900**

City: **Salt Lake City** State: **UT** ZIP: **84101**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41) \$ **40.00**

- ☒ Enclosed
☒ Authorized to be charged to deposit account (any deficiencies)

8. Deposit account number:

13-0763

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Evan R. Witt

Name of Person Signing

Signature

May 6, 1999

Date

Total number of pages including cover sheet, attachments, and document: **2**

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Documents to be recorded with required cover sheet information to:
Commissioner of Patents and Trademarks, Box Assignments
Washington, D.C. 20231

PATENT
REEL: 009954 FRAME: 0633

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

(1) Ming-Kwei Lee and Wen-Han Hung

HEREBY SELL(S), ASSIGN(S) AND TRANSFER(S) TO

(2) Winbond Electronics Corp. having a place of business at

(3) No. 4 Creation Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

(hereinafter called "ASSIGNEE") the entire right, title and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled

(4) METHOD FOR FORMING A TITANIUM DIOXIDE LAYER

which application was:

(a) executed by the undersigned on (5a) May 4, 1999

(b) filed on (5b) _____

and assigned Serial No. _____

including any and all United States letters Patents which may be granted on said application, and any and all extensions, divisions, reissues, substitutes, renewals or continuations of said application and patents, and the right to all benefits under all international conventions for the protection of industrial property and applications for said improvements.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee, its assigns or its successors in interest or its designee.

Upon said consideration, it is further agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining patent protection as provided herein.

DATE:

May 4, 1999

May 4, 1999

INVENTOR(S)

Ming-Kwei Lee

Ming-Kwei Lee

Wen-Han Hung

Wen-Han Hung

WITNESSES: